

Shenzhen Hi-Link Electronic Co.,Ltd HLK-7688A Datasheet



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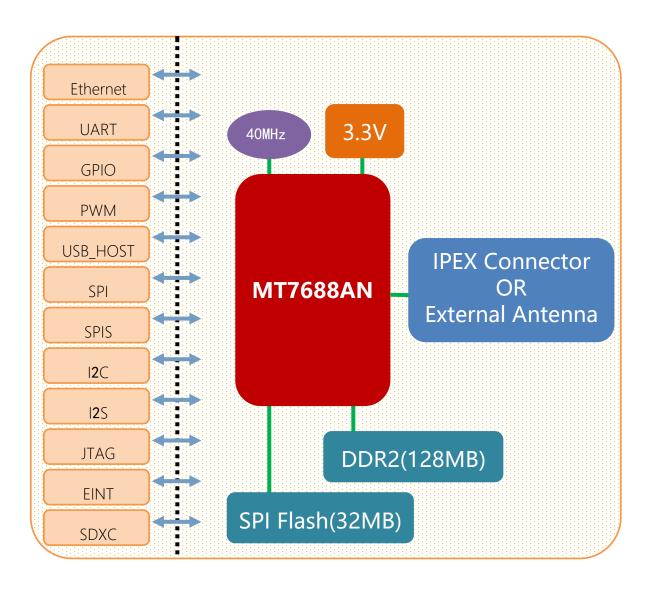
1.INTRODUCTION

HLK-MT7688A based on MT7688AN is a low cost and low power consumption IOT module developed by Hi-Link. The module supports Linux, OpenWRT operating system and custom development. It could be widely applied to smart devices or cloud services application with its rich interface and powerful processors.

1.1. BASIC PARAMETERS

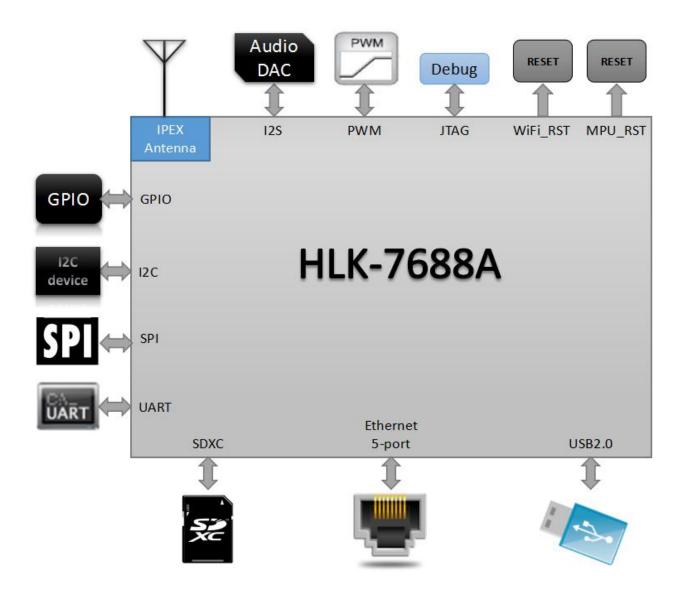
- High data processing ability, MCU frequency 580MHz
- 150M Mbps
- Support 802.11b/g/n
- 20/40 Channel bandwidth
- Support 802.11v
- Support AP,STA and AP,STA mixed
- Five 10/100M ETH PORT
- 1 USB2.0 Host interface port
- Interface SPI/SD-XC/eMMC
- Rich peripheral interfaces, SPI,I2C,I2S,PCM,UART,JTAG,GPIO
- Widely used in IOT
- Inbuilt powerful PMU
- Support 16 Multiple BSSID
- Support multiple security methods WEP64/128, TKIP, AES, WPA, WPA2, WAPI
- Support QoS, WMM, WMM-PS
- Support Linux 2.6.36 SDK, OpenWrt 3.10

2. Diagram



HLK-7688 structure

2.1. Typical application



HLK-7688A typical peripheral interfaces

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2.2. Specification

Item	Parameter
Model	HLK-7688A
Chipset	MT7688AN
Kernel	MIPS24KEc
Basic frequency	580MHz
RAM	DDR2 128MB
Flash	32MB
Temperature	Environmental temperature: -40°C~85°C
Humidity	working: 10~95% (noncondensing) Storage: 5~95% (noncondensing)
Size	18mm×32.8mm×2.8mm

2.3. Interfaces

Interface	Module interface	Factory default firmware supported interfaces
WiFi standard	IEEE 802.11b/g/n	Y
Ethernet Interface	5 10M/100M adjustable	1 WAN、4 LAN
UART	3 line	2 UART ports
SDIO	1 line	N
SPI	1 line	N
I2C	1 line	N
I2S	1 line	N

PWM	1line	N
GPIO	8 or more	Defined functions

NOTES:

- 1, The defalut firmware is based on linux development, the Ethernet, WiFi, Uart0 and Uart1have the transparent transmission functions.
- 2, We also could upgrade openwrt firmware or customized firmware.

3. ELECTRONICAL CHARACTERISTICS

3.1. Input voltage

Item	Function	MIN Voltage (V)	Typical	Max voltage
VBAT	Power voltage	3	3. 3	3.6
I/0	I/O voltage	3	3. 3	3.6

3.2. RF PERFORMANCE

3.2.1. 802.11b 11M

802.11b Transmit (Conductive)					
Item	Condition	Min.	Тур.	Max.	Unit
Frequency Range		Channel 1		Channel 13	
Tx Power Level	DQPSK	18	20	22	dBm
Frequency Tolerance		-15	0	15	ppm
	11MHz→22MHz		40		dBr
Spectral Mask	>22MHz		53		dBr
Modulation Accuracy	All Data Rate		15		%
802.11b Receiver (Conductive)					

Item	Condition	Min.	Тур.	Max.	Unit
Frequency Range		Channel 1		Channel 13	
Min. Input	11Mbps PER<8%	-91.5	-89.5	-87.5	dBm

3.2.2. 802.11g 54M

802.11g Transmit (Conductive)					
Item	Condition	Min.	Тур.	Max.	Unit
Frequency Range		Channel 1		Channel 13	
Tx Power Level	OFDM	15	17	19	dBm
Frequency Tolerance		-15	0	15	ppm
Modulation Accuracy	All Data Rate		-31	-28	%
	802.11g H	Receiver (Co	onductive)		
Item	Condition	Min.	Тур.	Max.	Unit
Frequency Range		Channel 1		Channel 13	
Min. Input	54Mbps PER<10%	-78.0	-76.0	-74.0	dBm

3.2.3. 802.11n MCS7(HT20)

802.11n_HT20 Transmit (Conductive)						
Item	Condition	Min.	Тур.	Max.	Unit	
Frequency Range		Channel 1		Channel 13		
Tx Power Level	OFDM	15	17	19	dBm	
Frequency Tolerance		-15	0	15	ppm	
Modulation Accuracy	All Data Rate		-31	-28	dB	
	802.11n_HT20 Receiver (Conductive)					
Item	Condition	Min.	Тур.	Max.	Unit	
Frequency Range		Channel 1		Channel 13		

3.2.4. 802.11n_MCS7(HT40)

Modulation Accuracy

802.11n_HT40 Transmit (Conductive)					
Item	Condition	Min.	Тур.	Max.	Unit
Frequency Range		Channel 1		Channel 13	
Tx Power Level	OFDM	15.0	17.0	19.0	dBm
Frequency Tolerance		-15	0	15	ppm

802.11n_HT40 Receiver (Conductive)

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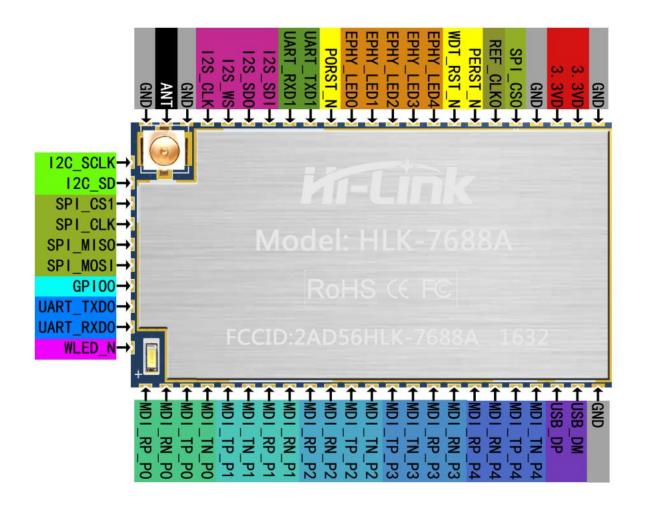
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Item	Condition	Min.	Тур.	Max.	Unit
Frequency Range		Channel 1		Channel 13	
Min. Input	MCS7 PER<10%	-76. 5	-74. 5	−72. 5	dBm

4. MODULE PINS DEFINITION

All Data Rate

4.1. DEFAULT PINS DEFINITION



HLK-7688A default definition

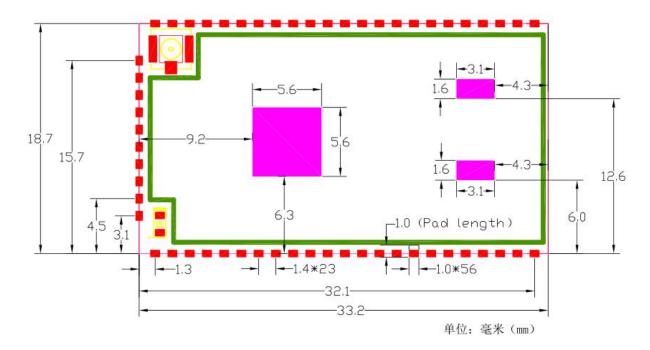
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4.2. DEGAULT PINS DEFINITION

	Name										
	(function										
PIN	1)	Function 2	Function 3	Function 4	GPI0	Note					
1	GND										
2		3.3VD supply current≥800mA									
3		3.3VD supply current≥800mA									
4				GND							
5	SPI_CS0										
6	REF_CLKO				GPI038	Time output					
7	PERST_N				GPI036	PCIe device reset					
8	WDT_RST_N				GPI037						
9	EPHY_LED4	JTAG_RST_N			GPI039						
10	EPHY_LED3	JTAG_CLK			GPI040						
11	EPHY_LED2	JTAG_TMS			GPI041						
12	EPHY_LED1	JTAG_TDI			GPI042						
13	EPHY_LEDO	JTAG_TDO			GPI043						
14	PORST_N					Reset					
15	UART_TXD1			PWM_CHO	GPI045	UART 1 data transmission					
16	UART_RXD1			PWM_CH1	GPI046	UART 1 data receiving					
17	I2S_SDI	PCMDRX			GPI00						
18	I2S_SDO	PCMDTX			GPI01						
19	I2S_WS	PCMCLK			GPI02						
20	I2S_CLK	PCMFS			GPI03						
21				GND							
22	ANT										
23				GND							
24	I2C_SCLK				GPI04						
25	I2C_SD				GPI05						
26	SPI_CS1				GPI06						
27	SPI_CLK				GPI07						
28	SPI_MISO				GPI09						

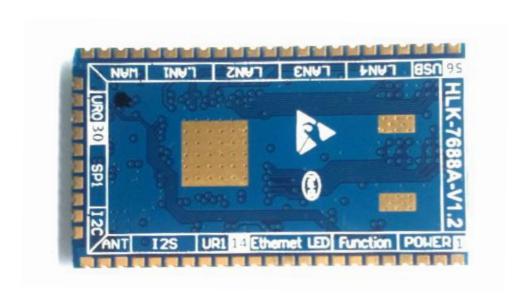
29	SPI_MOSI				GPI08	
30	GPI00				GPI011	
31	UART_TXD0				GPI012	UARTO data output
32	UART_RXD0				GPI013	UART O data input
33	WLED_N				GPI044	WiFi LED
34	MDI_RP_P0				GPI024	
35	MDI_RN_PO				GPI023	
36	MDI_TP_P0				GPI022	
37	MDI_TN_PO				GPI021	
38	MDI_TP_P1	SPIS_CS		PWM_CHO	GPI014	
39	MDI_TN_P1	SPIS_CLK		PWM_CH1	GPI015	
40	MDI_RP_P1	SPIS_MISO		UART_TXD2	GPI016	
41	MDI_RN_P1	SPI_MOSI		UART_RXD2	GPI017	
42	MDI_RP_P2		eMMC_D7	PWM_CHO	GPI018	
43	MDI_RN_P2		eMMC_D6	PWM_CH1	GPI019	
44	MDI_TP_P2	UART_TXD2	eMMC_D5	PWM_CH2	GPI020	
45	MDI_TN_P2	UART_RXD2	eMMC_D4	PWM_CH3	GPI021	
46	MDI_TP_P3	SD_WP	eMMC_WP		GPI022	
47	MDI_TN_P3	SD_CD	eMMC_CD		GPI023	
48	MDI_RP_P3	SD_D1	eMMC_D1		GPI024	
49	MDI_RN_P3	SD_D0	eMMC_DO		GPI025	
50	MDI_RP_P4	SD_CLK	eMMC_CLK		GPI026	
51	MDI_RN_P4	SD_CMD	eMMC_CMD		GPI028	
52	MDI_TP_P4	SD_D3	eMMC_D3		GPI029	
53	MDI_TN_P4	SD_D2	eMMC_D2		GPI027	
54	USB_DP					
55	USB_DM					
56				GND		

5. DIMENSIONS



Notes:

- 1, The middle three pads are hot pads, please make it grounded.
- 2, The size of the pad around the module is 1x1mm.
- 3, For packing, external pads recommended for 1x2mm, internal hot pads reduce size properly. Recommended size:5x5mm, 1.5x2.5mm, 1.5x2.5mm.

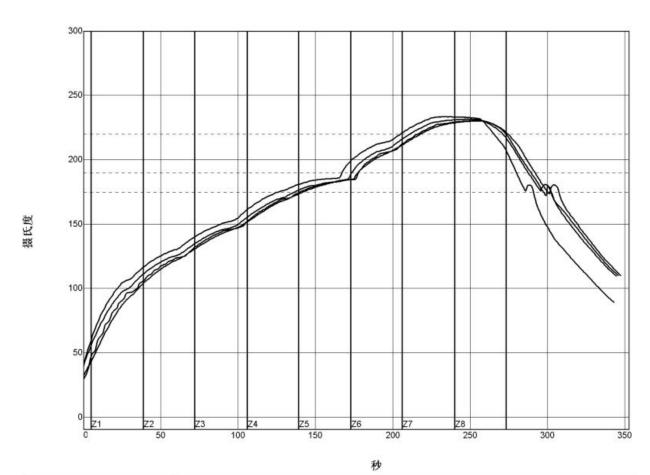


$\mathbf{6.}\ \mathbf{T}$ EMPERATURE reflow profile

When the module pases through the furnaces again, please according to the temperature curve. The reflow temperature with much difference will easily demage module.

Temperature setting (°C)									
Temp.	1	2	3	4	5	6	7	8	
zone									
Upper	125	135	155	185	195	225	240	230	
Lower	125	135	155	185	195	225	240	230	
1:. 70.0 : 1 / :									

line: 70.0 inch/min



PWI= 94%	恒温时间175至190C		回流时间 /220C		最高温度	
<tc2></tc2>	35.53	-82%	55.58	-72%	230.28	-94%
<tc3></tc3>	37.66	-74%	58.66	-57%	230.56	-89%
<tc4></tc4>	41.52	-62%	60.63	-47%	233.62	-28%
<tc5></tc5>	37.07	-76%	60.44	-48%	231.67	-67%
温差	5.99		5.05	1 179	3.34	Je - 00000

制程界限:

锡音:	System Default for Reflow				
统计数名称		最低界限	最高界限	单位	
恒温时间175-190摄氏度 回流以上时间 - 220摄氏原	le .	30 50	90 90	杪	
最高温度	e.	230	240	度 摄氏度	